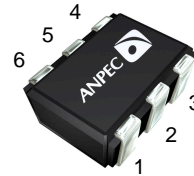


Load Switch with Level-Shift

**Features**

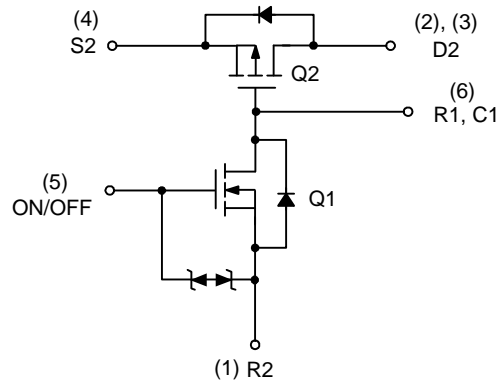
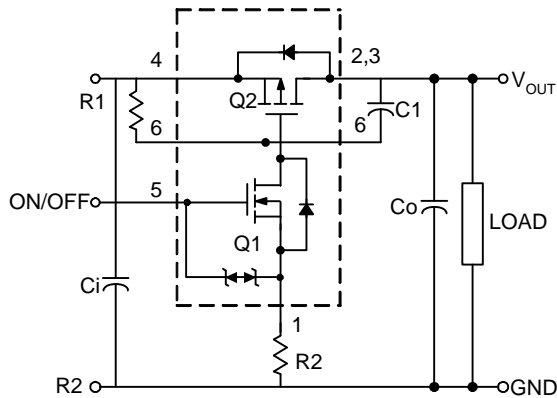
- -12V/±3A,  
 $R_{DS(ON)}=45m\Omega$  (typ.) @  $V_{GS}=-4.5V$   
 $R_{DS(ON)}=60m\Omega$  (typ.) @  $V_{GS}=-2.5V$   
 $R_{DS(ON)}=82m\Omega$  (typ.) @  $V_{GS}=-1.8V$
- Low Forward Voltage
- Lead Free and Green Devices Available  
 (RoHS Compliant)

**Pin Description**



Top View of JSOT-6

**Application Circuits**



**Ordering and Marking Information**

<p>APM2702 <span style="font-family: monospace;">□□□-□□□</span></p> <div style="margin-left: 20px;"> <p>└─ Assembly Material</p> <p>└─ Handling Code</p> <p>└─ Temperature Range</p> <p>└─ Package Code</p> </div>	<p>Package Code CG : JSOT-6</p> <p>Operating Junction Temperature Range C : -55 to 150 °C</p> <p>Handling Code TR : Tape &amp; Reel</p> <p>Assembly Material G : Halogen and Lead Free Device</p>
<p>APM2702 CG: <span style="border: 1px solid black; padding: 2px 5px; display: inline-block;">M2702 XXXXXX</span></p>	<p>XXXXXX - Date Code</p>

Note: ANPEC lead-free products contain molding compounds/die attach materials and 100% matte tin plate termination finish; which are fully compliant with RoHS. ANPEC lead-free products meet or exceed the lead-free requirements of IPC/JEDEC J-STD-020C for MSL classification at lead-free peak reflow temperature. ANPEC defines "Green" to mean lead-free (RoHS compliant) and halogen free (Br or Cl does not exceed 900ppm by weight in homogeneous material and total of Br and Cl does not exceed 1500ppm by weight).

ANPEC reserves the right to make changes to improve reliability or manufacturability without notice, and advise customers to obtain the latest version of relevant information to verify before placing orders.

**Absolute Maximum Ratings** ( $T_A = 25^\circ\text{C}$  unless otherwise noted)

Symbol	Parameter	Rating	Unit	
$V_{IN}$	Input Voltage	12	V	
$V_{ON/OFF}$	ON/OFF Voltage	8		
$I_L$	Load Current	Continuous <sup>a, b</sup>	$\pm 3$	A
		Pulsed <sup>b, c</sup>	$\pm 8$	
$I_S$	Diode Continuous Forward Current <sup>a</sup>	-1		
$T_J$	Maximum Junction Temperature <sup>a</sup>	150	°C	
$T_{STG}$	Storage Temperature Range	-55 to 150		
$P_D$	Maximum Power Dissipation <sup>a</sup>	$T_A=25^\circ\text{C}$	0.83	W
		$T_A=100^\circ\text{C}$	0.3	
$R_{\theta JA}$	Thermal Resistance-Junction to Ambient	150	°C/W	

Note a : Surface Mounted on FR4 Board.

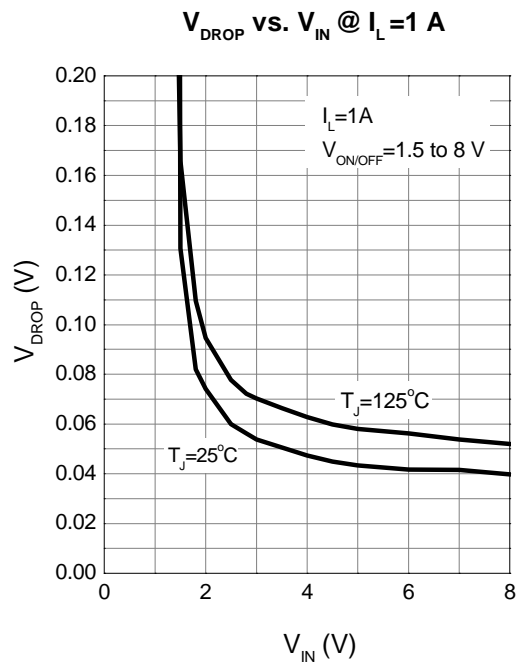
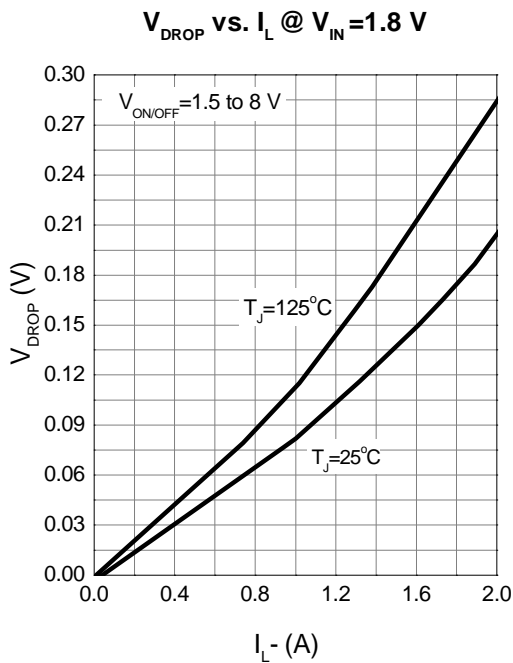
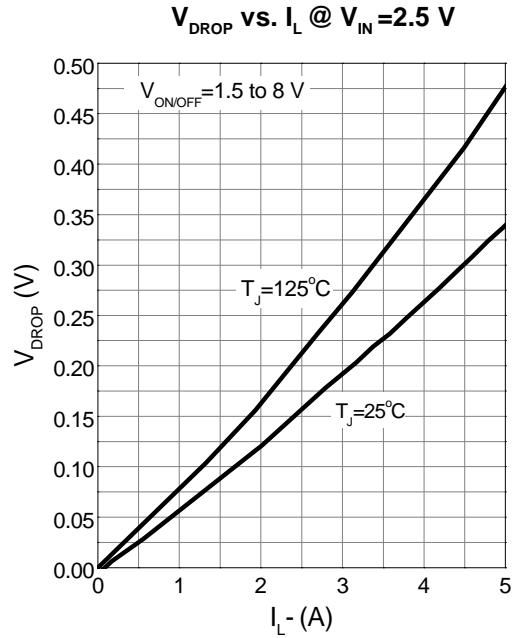
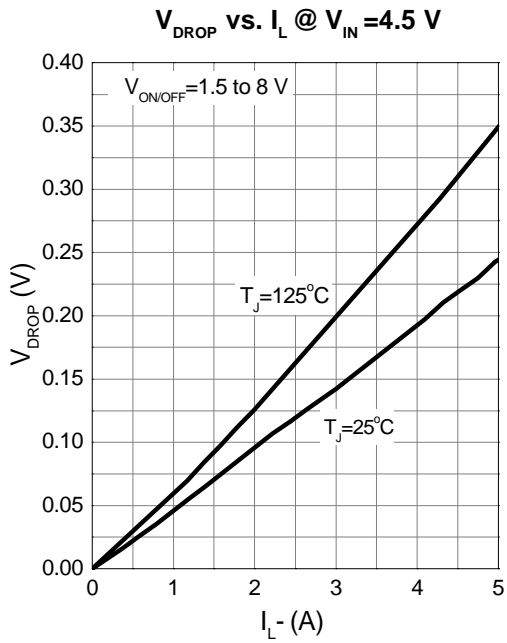
Note b :  $V_{IN}=8\text{V}$ ,  $V_{ON/OFF}=8\text{V}$ ,  $T_A=25^\circ\text{C}$ .

Note c : Pulse test: pulse width $\leq 300\mu\text{s}$ , duty cycle $\leq 2\%$ .

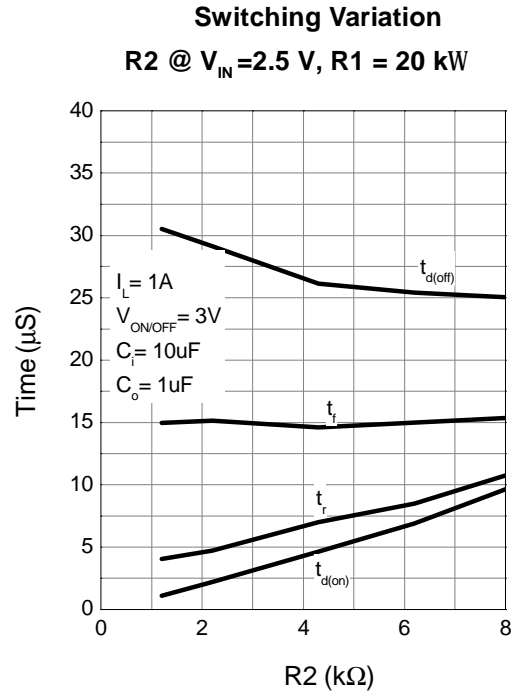
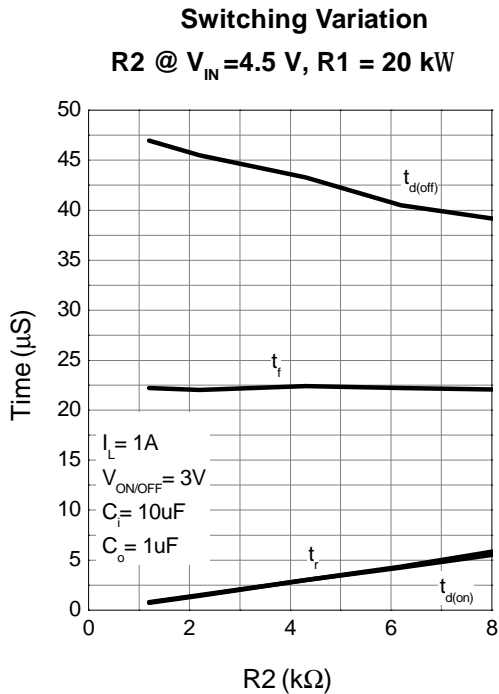
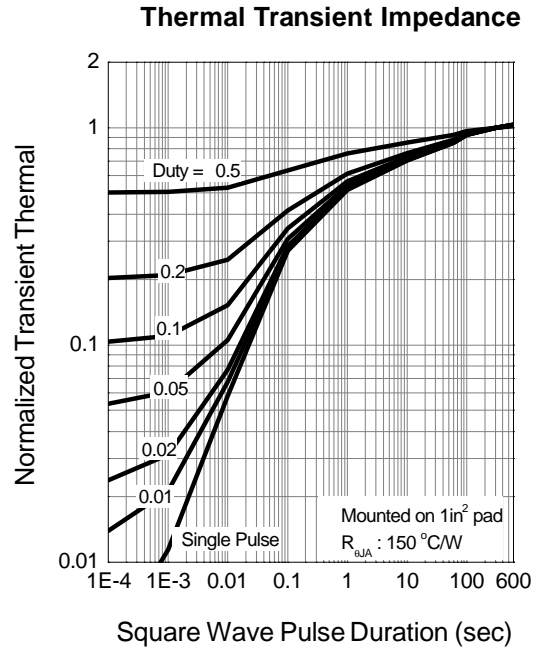
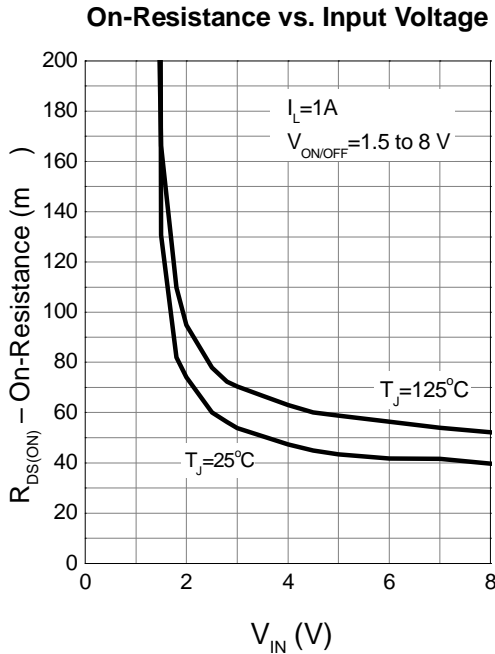
**Electrical Characteristics** ( $T_A = 25^\circ\text{C}$  Unless Otherwise Noted)

Symbol	Parameter	Test Conditions	APM2702CG			Unit
			Min.	Typ.	Max.	
<b>OFF Characteristics</b>						
$I_{FL}$	Reverse Leakage Current	$V_{IN}=8\text{V}, V_{ON/OFF}=0\text{V}$	-	-	1	$\mu\text{A}$
$V_{SD}$	Diode Forward Voltage	$I_S=-1\text{A}$	-	-0.7	-1.3	V
<b>ON Characteristics</b>						
$V_{IN}$	Input Voltage Range		1.8	-	12	V
$R_{DS(ON)}$	On-Resistance (p-channel)	$V_{IN}=-4.5\text{V}, I_{DS}=-3\text{A}$	-	45	60	m $\Omega$
		$V_{IN}=-2.5\text{V}, I_{DS}=-2\text{A}$	-	60	85	
		$V_{IN}=-1.8\text{V}, I_{DS}=-1\text{A}$	-	82	150	
$I_{D(ON)}$	On-State (p-channel) Drain-Current	$V_{IN-OUT} 0.2\text{V}, V_{IN}=5\text{V}, V_{ON/OFF}=1.5\text{V}$	1	-	-	A
		$V_{IN-OUT} 0.3\text{V}, V_{IN}=3\text{V}, V_{ON/OFF}=1.5\text{V}$	1	-	-	

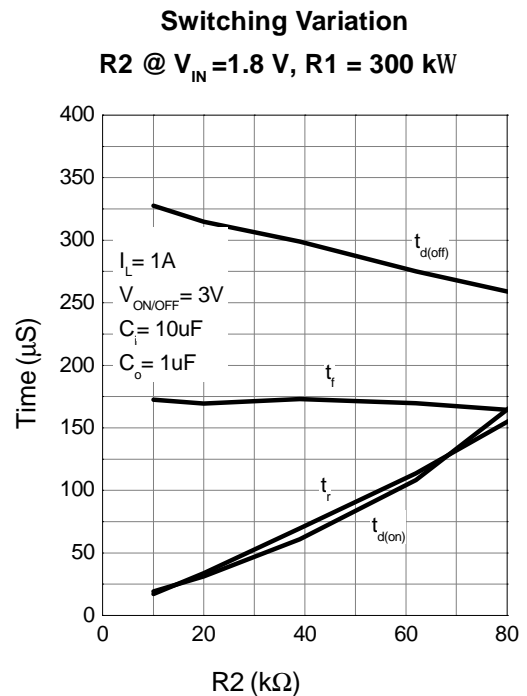
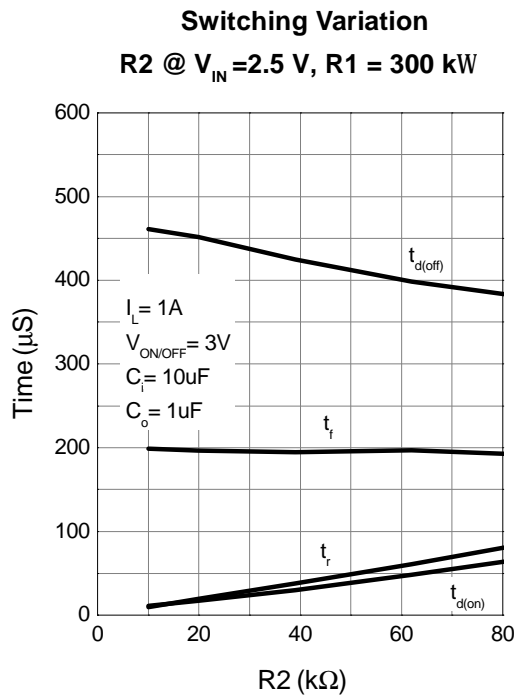
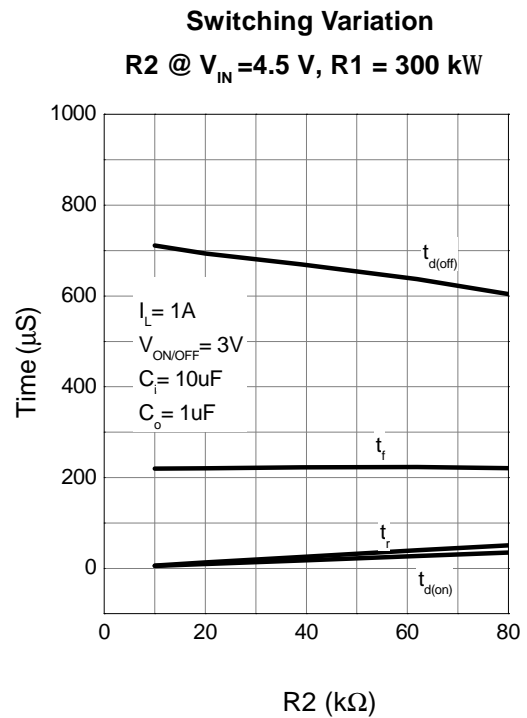
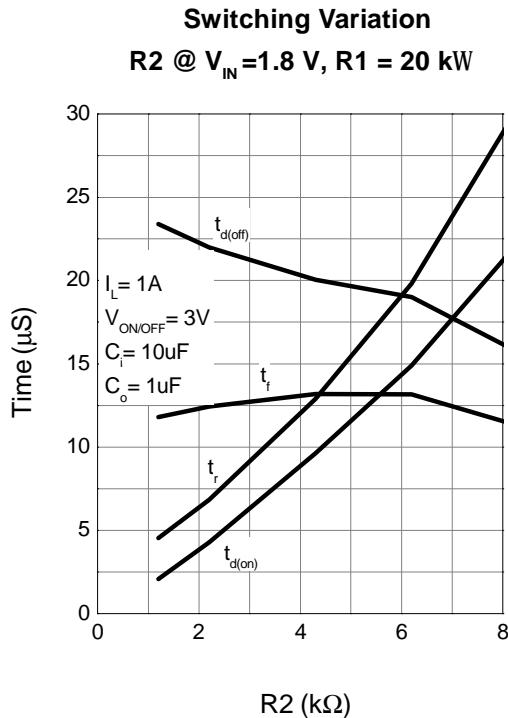
### Typical Operating Characteristics



Typical Operating Characteristics (Cont.)

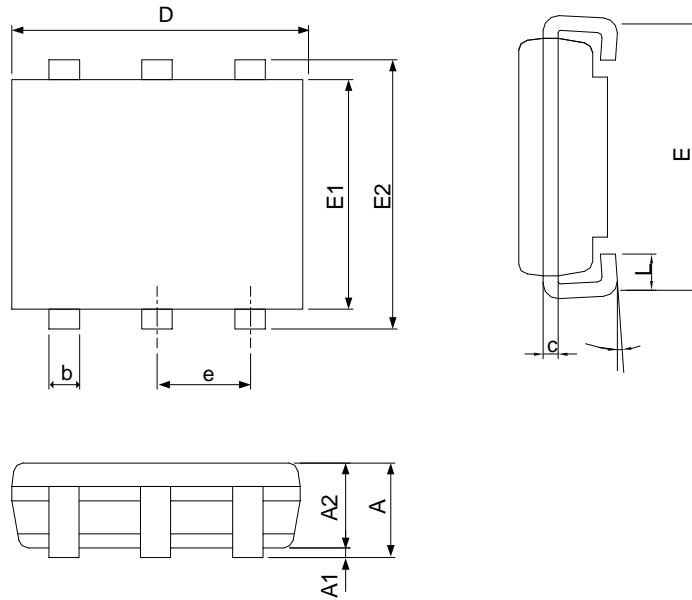


Typical Operating Characteristics (Cont.)



Package Information

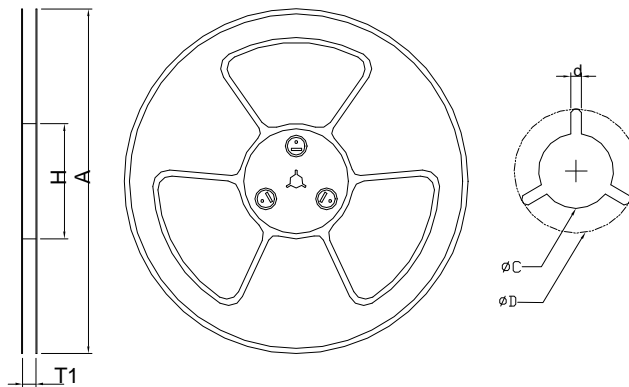
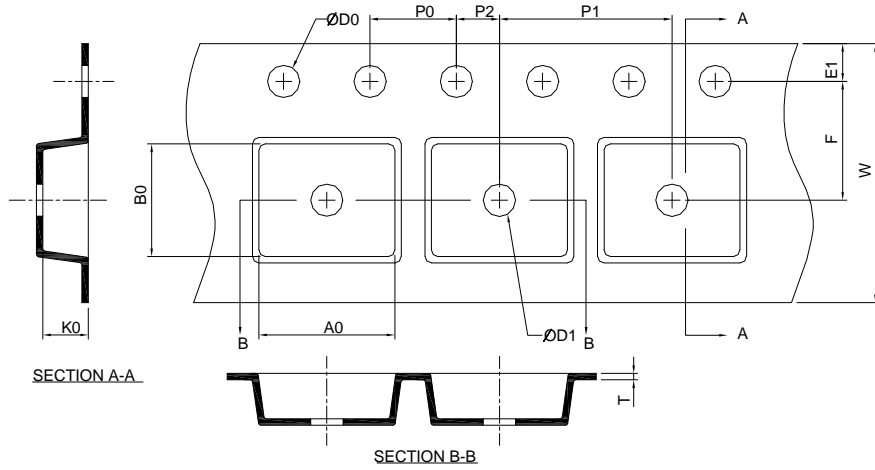
JSOT-6



Symbol	JSOT-6			
	MILLIMETERS		INCHES	
	MIN.	MAX.	MIN.	MAX.
A	0.93	1.10	0.037	0.043
A1	0.01	0.10	0.000	0.004
A2	0.92	1.00	0.036	0.039
b	0.25	0.40	0.010	0.016
c	0.10	0.20	0.004	0.008
D	2.95	3.10	0.116	0.122
E	2.50	3.00	0.098	0.118
E1	2.30	2.50	0.091	0.098
E2	2.65	3.05	0.104	0.120
e	0.95 BSC		0.037 BSC	
$\theta$	0°	8°	0°	8°
L	0.30	0.60	0.012	0.024

Note : 1. Follow GEM 2928 6J.  
 2. Dimension D, D1, and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed 10 mil.

### Carrier Tape & Reel Dimensions



Application	A	H	T1	C	d	D	W	E1	F
JSOT-6	178.0 ±2.00	50 MIN.	8.4+2.00 -0.00	13.0+0.50 -0.20	1.5 MIN.	20.2 MIN.	8.0 ±0.30	1.75 ±0.10	3.5 ±0.05
	P0	P1	P2	D0	D1	T	A0	B0	K0
	4.0 ±0.10	4.0 ±0.10	2.0 ±0.05	1.5+0.10 -0.00	1.0 MIN.	0.6+0.00 -0.40	3.20 ±0.20	3.10 ±0.20	1.50 ±0.20

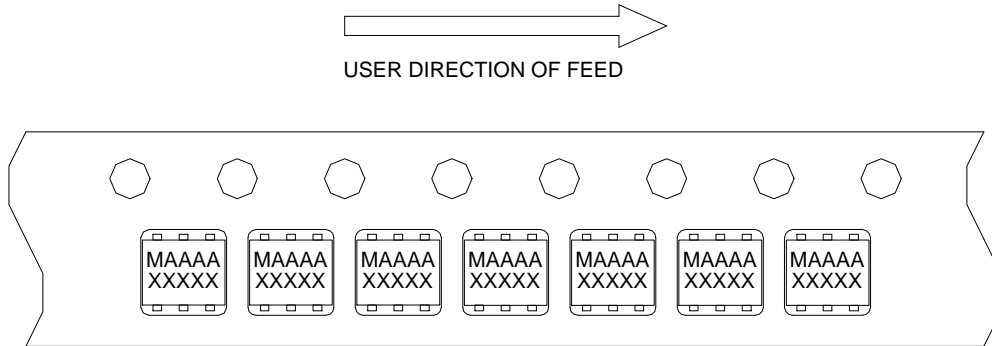
(mm)

### Devices Per Unit

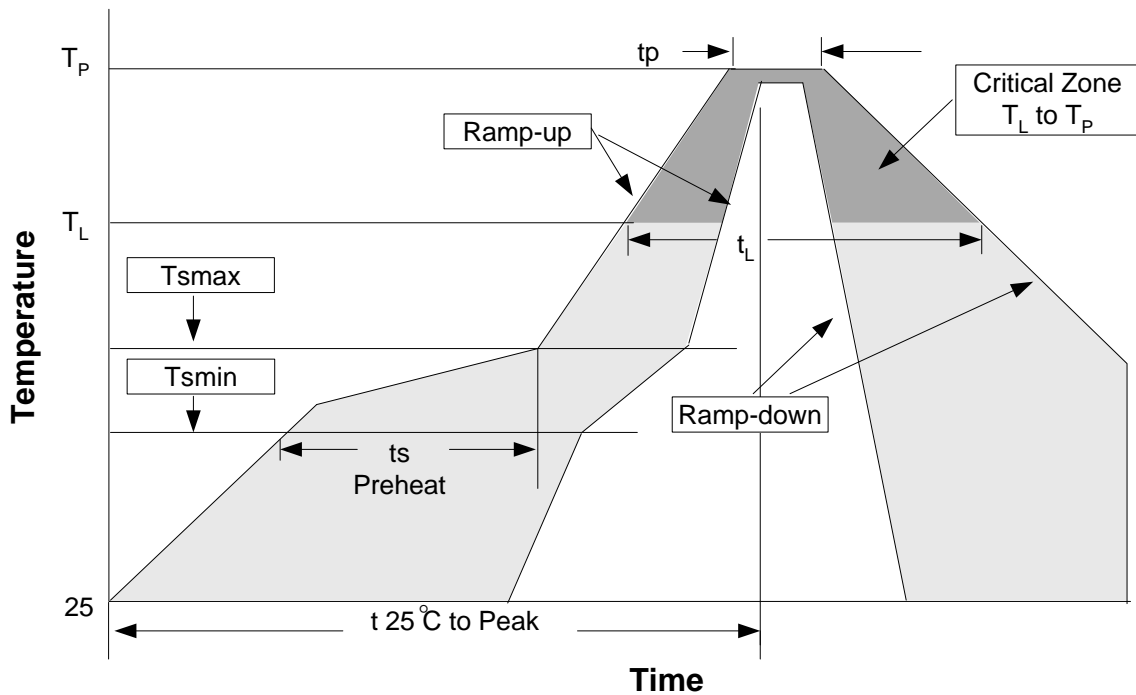
Package Type	Unit	Quantity
JSOT-6	Tape & Reel	3000

## Taping Direction Information

JSOT-6



## Reflow Condition (IR/Convection or VPR Reflow)



## Reliability Test Program

Test item	Method	Description
SOLDERABILITY	MIL-STD-883D-2003	245°C, 5 sec
HOLT	MIL-STD-883D-1005.7	1000 Hrs Bias @125°C
PCT	JESD-22-B, A102	168 Hrs, 100%RH, 121°C
TST	MIL-STD-883D-1011.9	-65°C~150°C, 200 Cycles



## Classification Reflow Profiles

Profile Feature	Sn-Pb Eutectic Assembly	Pb-Free Assembly
Average ramp-up rate (T <sub>L</sub> to T <sub>P</sub> )	3°C/second max.	3°C/second max.
Preheat - Temperature Min (T <sub>smin</sub> ) - Temperature Max (T <sub>smax</sub> ) - Time (min to max) (t <sub>s</sub> )	100°C 150°C 60-120 seconds	150°C 200°C 60-180 seconds
Time maintained above: - Temperature (T <sub>L</sub> ) - Time (t <sub>L</sub> )	183°C 60-150 seconds	217°C 60-150 seconds
Peak/Classification Temperature (T <sub>p</sub> )	See table 1	See table 2
Time within 5°C of actual Peak Temperature (t <sub>p</sub> )	10-30 seconds	20-40 seconds
Ramp-down Rate	6°C/second max.	6°C/second max.
Time 25°C to Peak Temperature	6 minutes max.	8 minutes max.

Note: All temperatures refer to topside of the package. Measured on the body surface.

Table 1. SnPb Eutectic Process – Package Peak Reflow Temperatures

Package Thickness	Volume mm <sup>3</sup> <350	Volume mm <sup>3</sup> ≥350
<2.5 mm	240 +0/-5°C	225 +0/-5°C
≥2.5 mm	225 +0/-5°C	225 +0/-5°C

Table 2. Pb-free Process – Package Classification Reflow Temperatures

Package Thickness	Volume mm <sup>3</sup> <350	Volume mm <sup>3</sup> 350-2000	Volume mm <sup>3</sup> >2000
<1.6 mm	260 +0°C*	260 +0°C*	260 +0°C*
1.6 mm – 2.5 mm	260 +0°C*	250 +0°C*	245 +0°C*
≥2.5 mm	250 +0°C*	245 +0°C*	245 +0°C*

\*Tolerance: The device manufacturer/supplier **shall** assure process compatibility up to and including the stated classification temperature (this means Peak reflow temperature +0°C. For example 260°C+0°C) at the rated MSL level.

## Customer Service

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